

# Lithium-Ion Battery Charge Control (microcomputer-controlled type) (1 cell) Monolithic IC MM1475

## Outline

This IC is a lithium-ion battery charge control IC. It is a one-chip charge control IC where the protection circuit incorporates constant-current/constant-voltage charge and precharge, precharge timer, and battery temperature detection functions. As opposed to MM1433, the fast-charge timer and full-charge detection function have been eliminated, and charge ON/OFF is controlled externally.

## Features

- |  |   |
|--|---|
| 1. Output voltage (Ta = 0°C ~ +50°C)                     | 4.120 ± 30mV                            |
| 2. Current consumption                                   | 3.5mA typ.                              |
| 3. Precharge function                                    |   |
| 4. Adaptor (primary side) abnormality detection function |   |
| 5. Timer error time                                      | ±10% (not including external deviation) |
| 6. Battery temperature detection function                |   |
| 7. Precharge timer                                       |   |

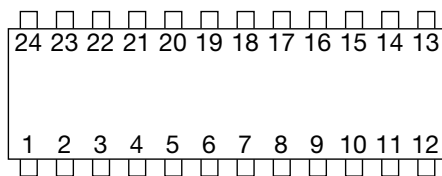
## Package

TSOP-24A

## Application

Lithium-ion battery charge control (with timer)

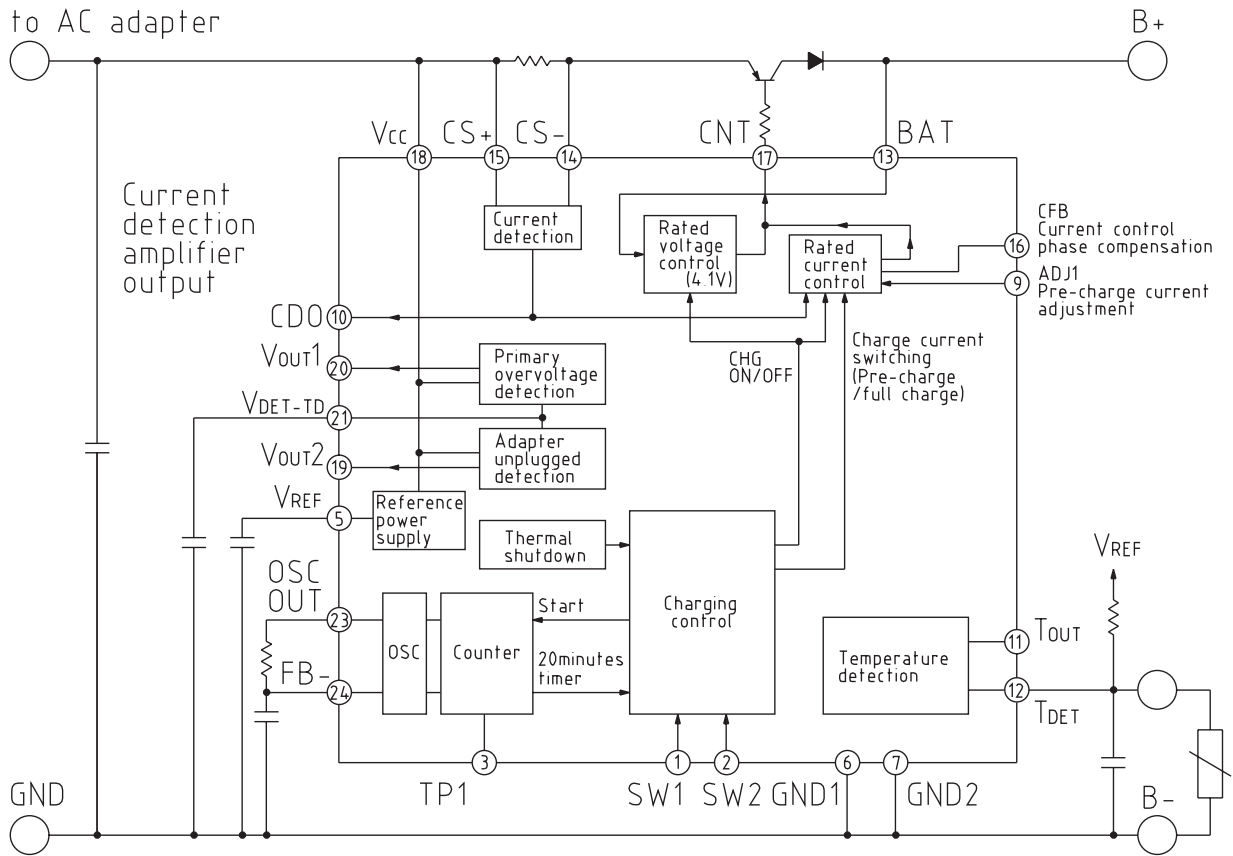
## Pin Assignment



TSOP-24A

1	SW1	13	BAT
2	SW2	14	CS-
3	TP1	15	CS+
4	N.C	16	CFB
5	VREF	17	CNT
6	GND1	18	V <sub>CC</sub>
7	GND2	19	V <sub>OUT2</sub>
8	N.C	20	V <sub>OUT1</sub>
9	ADJ1	21	VDET-TD
10	CDO	22	N.C
11	T <sub>OUT</sub>	23	OSC OUT
12	TDET	24	OSC FB-

Block Diagram



SW1	SW2	Charging	Current limit	Timer
L	H	OFF		OFF
H	H	ON	Controlled by this IC (Current limit 2: 25mV)	ON
L	L	ON	Controlled by adaptor (Current limit 1: 450mV)	OFF
H	L	ON	Controlled by adaptor (Current limit 1: 450mV)	OFF

Pin Description

Pin No.	Pin name	I/O Function	Function
1	SW1	Input	Charge control switching pin.
2	SW2	Input	Switches charging ON/OFF and switches charging current by combinations of SW1 and SW2 high and low.
3	TP1	Input/output	Test pin 1. Pre-charge timer test pin. Inverts during counting (from the middle stage of the several-staged FF) and outputs on TP1 for monitoring. Also inverts TP1 output signal again inside the IC and inputs to the next stage FF. (Timer setting done by binary counter.)
5	VREF	Output	Reference power supply output pin. Outputs 1.2V typ. reference voltage.
6	GND1	Input	GND pin.
7	GND2	Input	GND pin.
9	ADJ1	Input	Pre-charge current adjustment pin. Pin voltage is set at 100mV typ.. Pre-charge current can be changed by adjusting pin voltage with an external resistor. Pre-charge current is controlled by comparing ADJ1 pin voltage and the 12dB voltage drop value between CS + and CS -.
10	CDO	Output	Current detection output pin. Outputs voltage difference of 18dB between CS+ and CS -.
11	T <sub>OUT</sub>	Output	Temperature detection output pin. Normal temperature: Output Tr OFF When high temperature is detected: Output Tr ON
12	TDET	Input	Temperature detection input pin. Be sure to apply the potential obtained by resistance dividing, from reference voltage, with an external resistor and thermistor.
13	BAT	Input	Battery voltage input pin. Detects battery voltage and controls charging.
14	CS-	Input	Current detection pin.
15	CS+	Input	Detects current by voltage drop at external resistor between (CS+) and (CS-) and controls charging current.
16	CFB	Input	Rated current control phase compensation pin. Oscillation is improved by connecting an external capacitor (around 100pF) between CFB and CNT to perform phase compensation.
17	CNT	Output	Charging control output pin. Controls base of external PNP-Tr for rated current rated voltage charging.
18	V <sub>CC</sub>	Input	Power supply input pin.
19	V <sub>OUT2</sub>	Output	Adapter unplugged detection output pin. V <sub>CC</sub> low voltage input: Output Tr OFF V <sub>CC</sub> recommended operating voltage: Output Tr ON
20	V <sub>OUT1</sub>	Output	Overvoltage detection output pin. V <sub>CC</sub> overvoltage input: Output Tr OFF V <sub>CC</sub> recommended operating voltage: Output Tr ON
21	VDET-TD	Input	Overvoltage detection delay time setting pin. Delay time is set by connecting an external capacitor.
23	OSC OUT	Output	Oscillator output pin. Timer setting time changes according to oscillation frequency. Oscillation frequency is determined by the external resistor (connected between OSC OUT and OSC FB) and capacitor (connected between OSC FB and GND).
24	OSC FB-	Input	Oscillator inverted input pin.

**Pin Description** The following valaeis typical

Pin No.	Pin name	Internal equivalent circuit diagram	Pin No.	Pin name	Internal equivalent circuit diagram
1	SW1		11	Tout	
			12	TDET	
2	SW2		13	BAT	
3	TP1				
4	NC		14	CS-	
5	VREF		15	CS+	
8	NC		16	CFB	
9	ADJ1		17	CNT	
10	CDO		19	Vout2	

Pin No.	Pin name	Internal Equivalent Circuit Diagram	Pin No.	Pin name	Internal Equivalent Circuit Diagram
20	V <sub>OUT1</sub>		22	NC	
			23	OSC OUT	
21	VDET-TD		24	OSC FB -	

### Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Storage temperature	T <sub>STG</sub>	-40~+125	°C
Operating temperature	T <sub>OPR</sub>	-20~+70	°C
Power supply voltage	V <sub>CCmax.</sub>	-0.3~+15	V
Allowable loss	P <sub>d</sub>	250	mW

### Recommended Operating Conditions

Item	Symbol	Rating	Unit
Operating temperature	T <sub>OPR</sub>	-20~+70	°C
Charging control operating voltage	V <sub>OPR</sub>	3.0~5.8	V

**Electrical Characteristics** (Except where otherwise indicated: Ta = 25°C, Vcc = 5V)

Item	Symbol	Measurement conditions	Measurement pin	Min.	Typ.	Max.	Unit
Consumption current 1	ICC1	SW1, 2 : H	18		3.5	5.0	mA
Consumption current 2	ICC2	SW1, 2 : L	18		5.5	7.7	mA
Reference voltage	VREF		5		1.207		V
ADP detection voltage L	VADPL	VCC : H→L	19	2.70	2.80	2.90	V
ADP detection voltage L Hysteresis voltage width	VADPLW		19	50	100	150	mV
ADP detection voltage H	VADPH	VCC : L→H	20	5.8	6.0	6.2	V
ADP detection voltage H Hysteresis voltage width	VADPHW		20	50	100	150	mV
BAT pin leak current	IBAT		13			1	μA
BAT pin output voltage	VBAT	Ta=0~+50°C	13	4.090	4.120	4.150	V
CNT pin output voltage	VCNT	ICNT=20mA	17			0.5	V
SW1 pin input current	ISW1		1	40	60	80	μA
SW1 pin input voltage H	VSW1H		1	0.6		1.20	V
SW1 pin input voltage L	VSW1L		1			0.25	V
SW2 pin input current	ISW2		2	40	60	80	μA
SW2 pin input voltage H	VSW2H		2	0.6		1.20	V
SW2 pin input voltage L	VSW2L		2			0.25	V
Current limit 1	VL1	Rapid Charging	14, 15	0.35	0.45	0.55	V
Current limit 2	VL2	Preliminary Charging	14, 15	20	25	30	mV
Current detection amp gain	G1		10	17.5	18.0	18.5	dB
Current detection amp input offset voltage	VOFF		10	-4.5	0	4.5	mV
Current detection amp output current	ICDO		10	0.5	1.0		mA
VOUT1 pin output voltage	VOUT1	IOUT1=0.12mA	20		0.2	0.4	V
VOUT2 pin output voltage	VOUT2	IOUT2=0.12mA	19		0.2	0.4	V
Battery temperature detection voltage	VTDET	VTDET : H→L	11	0.390	0.413	0.435	V
Battery temperature detection voltage hysteresis voltage width	VTDETW		11	30	60	90	mV
TOUT pin output voltage	VTOUT	IOUT=0.12mA	11		0.2	0.4	V
TDET input bias current	IT		12		30	150	nA
Timer error time	ΔT	Excluding Dispersion	17	-10		10	%

\*Current limit 1 and 2 are prescribed by the current detection resistor voltage drop range.

\*If the control on this IC fails to work, its safety can not be guaranteed. Please protect with something other than this IC.

\*Please use a capacitor with good temperature characteristics in the OSC section. Capacitor deviation causes timer error.

Reference Materials on OSC CR Setting

■ (1) OSC CR – Oscillation cycle T Table

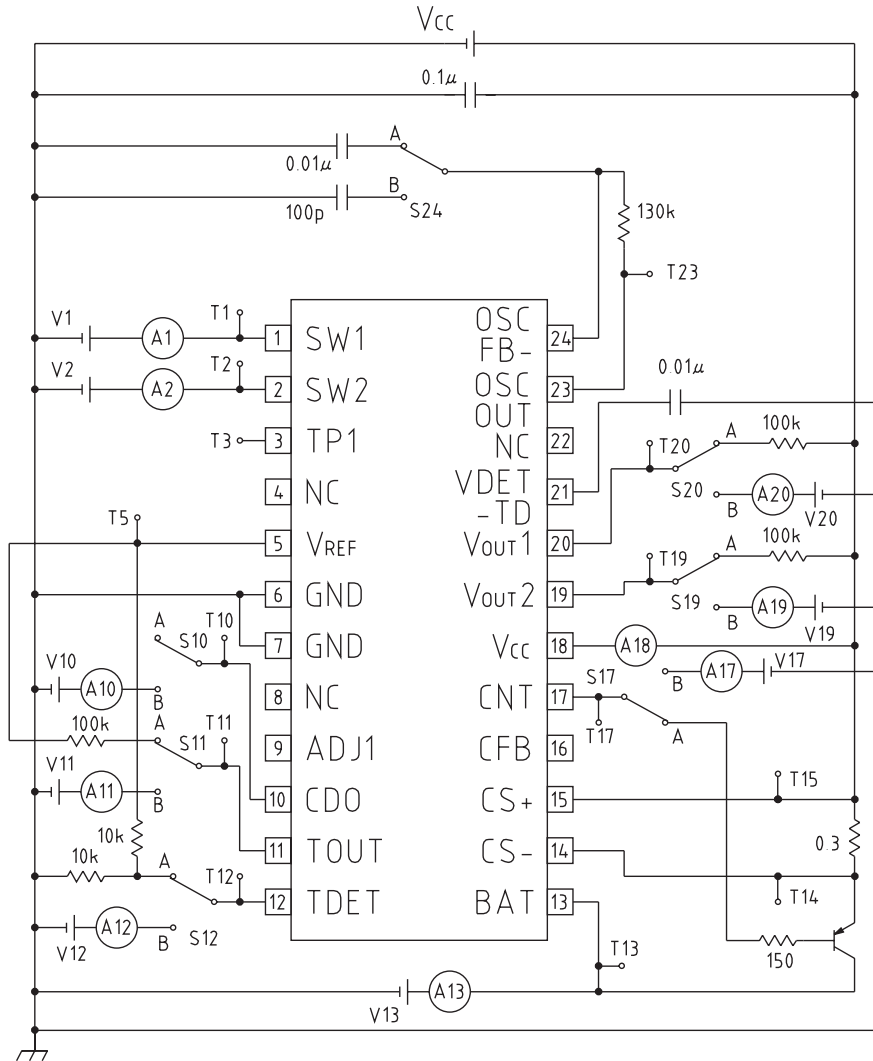
R \ C	75k	100k	120k	130k	150k	200k
0.0047μ	0.47ms	0.63ms	0.75ms	0.82ms	0.94ms	1.26ms
0.0082μ	0.83ms	1.10ms	1.32ms	1.43ms	1.65ms	2.20ms
0.01μ	1.03ms	1.37ms	1.63ms	1.77ms	2.04ms	2.73ms
0.015μ	1.48ms	1.98ms	2.38ms	2.58ms	2.97ms	3.95ms
0.022μ	2.16ms	2.87ms	3.44ms	3.73ms	4.30ms	5.76ms

■ (2) Timer Times

Item	Formula	Example (for C = 0.01μ, R = 130k)
Pre-charge timer	$T \times 2^{19}$	15min. 28s

T: OSC oscillation cycle

Measuring Circuit



**Measurement method**

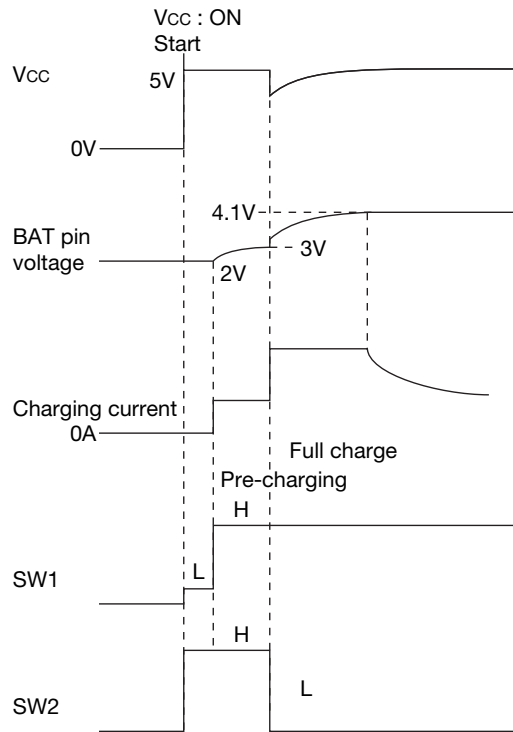
(Except where otherwise indicated,  $T_a = 25^\circ\text{C}$ ,  $V_{CC} = 5\text{V}$ ,  $V_{CC}$  : current limit 0.5A,  $V_1 = V_2 = 0\text{V}$ ,  $V_{13} = 4.2\text{V}$ , S10, 11, 12, 17, 19, 20, 24:A, timer time is not up)

Item	Measurement method
Consumption current 1	Measure A18 current value $I_{CC1}$ when $V_1 = V_2 = 1.2\text{V}$ .
Consumption current 2	Measure A18 current value $I_{CC2}$ .
Reference voltage	Measure T5 potential $V_{REF}$ .
ADP detection voltage L	Gradually lower $V_{CC}$ from 5V. $V_{CC}$ potential when T19 potential goes over $V_{CC} - 0.5\text{V}$ is $V_{ADPL}$ .
ADP detection voltage L Hysteresis voltage width	Gradually lower $V_{CC}$ from 2V. $V_{CC}$ potential when T19 potential drops below 0.5V is $V_{ADPL2}$ . $V_{ADPLW} = V_{ADPL2} - V_{ADPL}$
ADP detection voltage H	Gradually raise $V_{CC}$ from 5V. $V_{CC}$ potential when T20 potential goes over $V_{CC} - 0.5\text{V}$ is $V_{ADPH}$ .
ADP detection voltage H Hysteresis voltage width	Gradually lower $V_{CC}$ from 7V. $V_{CC}$ potential when T20 potential drops below 0.5V is $V_{ADPH2}$ . $V_{ADPHW} = V_{ADPH} - V_{ADPH2}$
BAT pin leak current	Measure A13 current value $I_{BAT}$ when $V_{CC} = 0\text{V}$ , S17: B, $V_{17} = 0\text{V}$ .
BAT pin output voltage	Gradually raise $V_{13}$ from 3.5V. T13 potential when T15-T14 potential difference is 20mV or less is $V_{BAT}$ .
CNT pin output voltage	Gradually raise $V_{17}$ from 0V when $V_{13} = 3.5\text{V}$ and S17: B. T17 potential when A17 current value reaches 20mA is $V_{CNT}$ .
SW1 pin input current	Measure A1 current value $I_{SW1}$ .
SW1 pin input voltage H	Change $V_1$ from 0V to 1.2V when $V_{13} = 3.5\text{V}$ and $V_2 = 1.2\text{V}$ . To identify $V_{SW1}$ H and L, when A13 is over 50mA, charging is ON at current limit 2, and when A13 is 1mA or under, charging is OFF.
SW1 pin input voltage L	
SW2 pin input current	Measure A2 current value $I_{SW2}$ .
SW2 pin input voltage H	Change $V_2$ from 0V to 1.2V when $V_{13} = 3.5\text{V}$ . To identify $V_{SW2}$ H and L, when A13 is over 450mA, charging is ON at current limit 1, and when A13 is 1mA or under, charging is OFF.
SW2 pin input voltage L	
Current limit 1	Gradually raise $V_{CC}$ current limit value when $V_{13} = 3.5\text{V}$ , and measure T15-T14 potential difference $V_{L1}$ .
Current limit 2	$V_{13} = 2.5\text{V}$ , $V_1 = V_2 = 1.2\text{V}$ , and T15-T14 potential difference is $V_{L2}$ .
Current detection amp gain	T15-T14 potential difference fluctuation is $\Delta V_a$ and T10 potential fluctuation is $\Delta V_b$ when $V_{13} = 3.5\text{V}$ and $V_{CC}$ current limit value is changed from 100mA to 200mA. $G_I = 20 \log  \Delta V_b / \Delta V_a $
Current detection amp input offset voltage	T10 potential is $V_{b2}$ when $V_{13} = 4.0\text{V}$ and $V_{CC}$ current limit value is 100mA. $V_{OFF} = V_{b2} / 8 - 30\text{mV}$
Current detection amp output current	Measure A10 current value when $V_{13} = 3.5\text{V}$ , $V_{CC}$ current limit value is 300mA, S10: B and $V_{10} = 0\text{V}$ .
$V_{OUT1}$ pin output voltage	Gradually raise $V_{20}$ from 0V when S20: B. T20 potential when A20 current value is 0.12mA is $V_{OUT1}$ .
$V_{OUT2}$ pin output voltage	Gradually raise $V_{19}$ from 0V when S19: B. $V_{19}$ potential when A19 current value is 0.12mA is $V_{OUT2}$ .
Battery temperature detection voltage	At S12:B, lower gradually from $V_{12} = 0\text{V}$ . T12 potential is $V_{TDET}$ when T11 potential falls below 0.3V.
Battery temperature detection voltage hysteresis voltage width	At S12:B, lower gradually from $V_{12} = 0\text{V}$ . T12 potential is $V_{TDET2}$ when T11 potential goes above 0.8V. $V_{TDETW} = V_{TDET2} - V_{TDET}$
$T_{OUT}$ pin output voltage	Raise $V_{11}$ gradually from 0V when S12:B, $V_{12} = 0\text{V}$ , S11:B. T11 potential is $V_{TOUT}$ when A11 current value is 0.12mA.
TDET input bias current	Measure A12 current value $I_T$ for S12:B, $V_{12} = 0\text{V}$ .

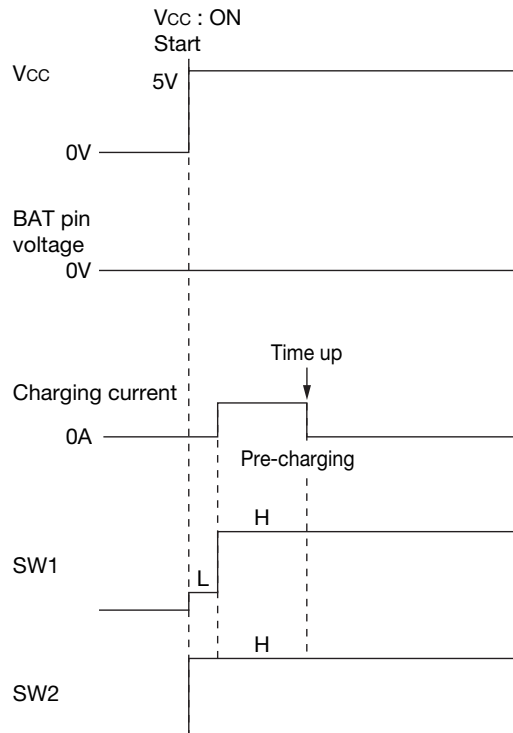


## Timing Chart

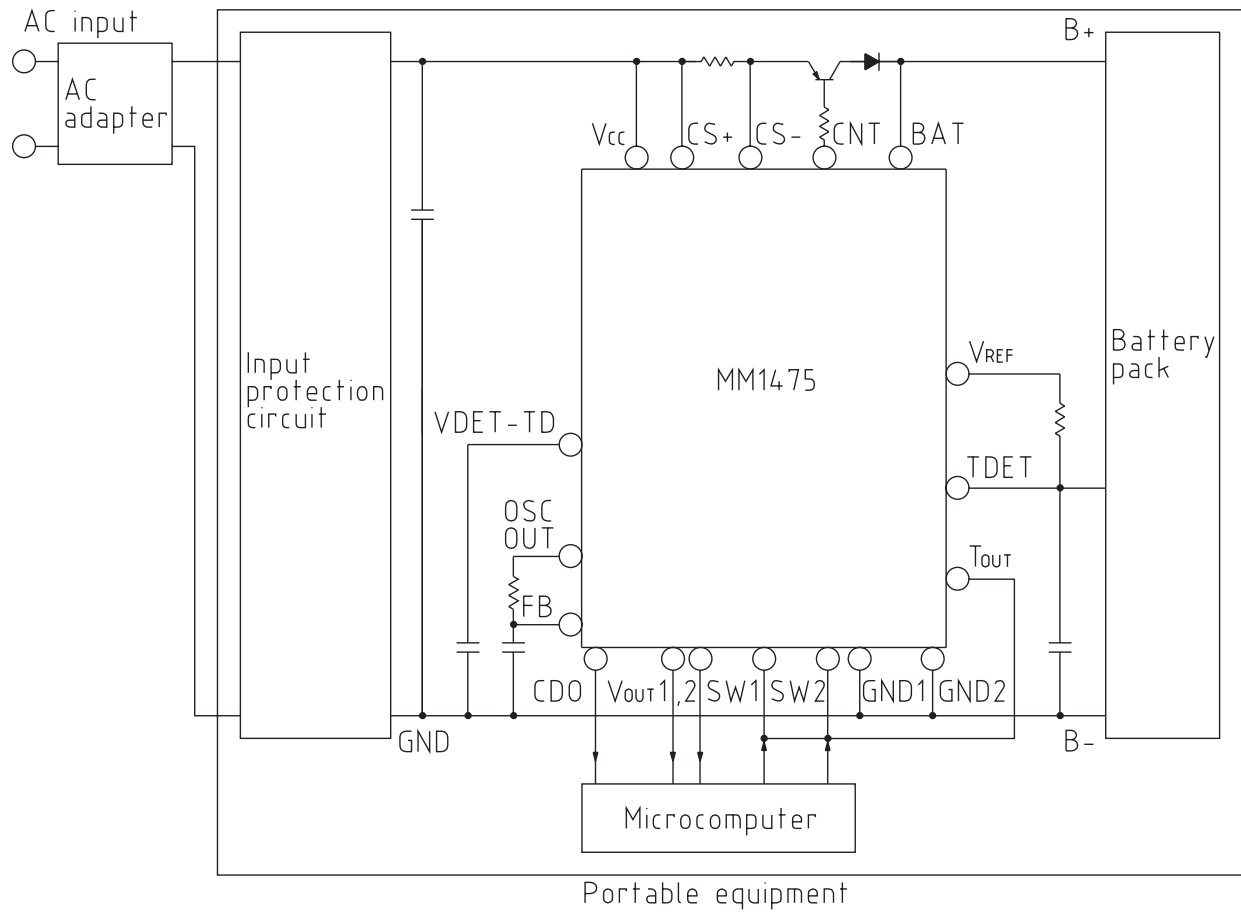
### ■ When charging is performed normally



### ■ Pre-Charging Time Up

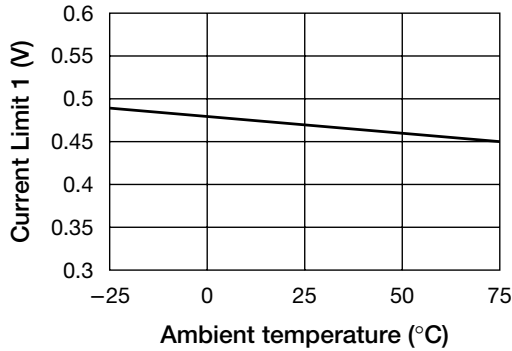


Application Circuit

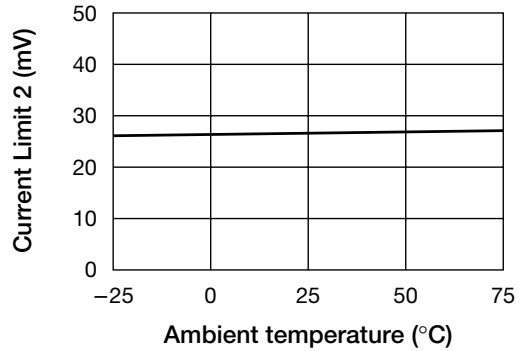


Characteristics

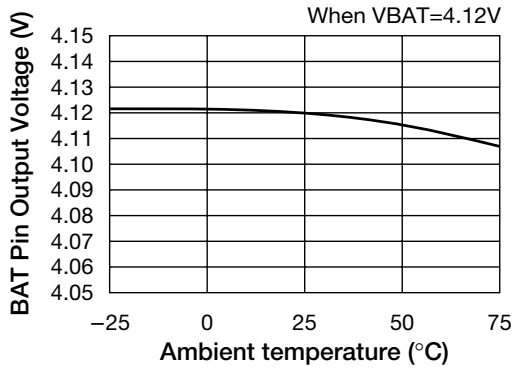
■ Current Limit 1 vs Ambient temperature



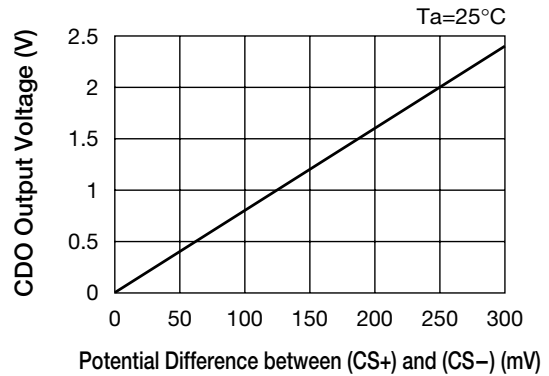
■ Current Limit 2 vs Ambient temperature



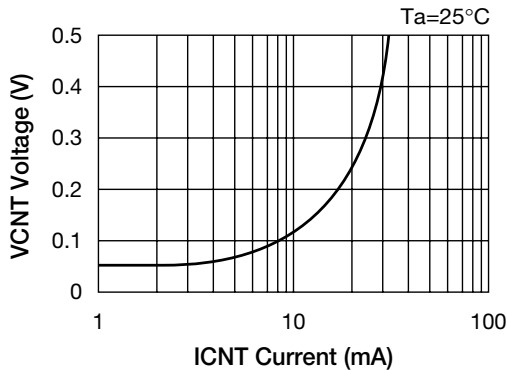
■ BAT Pin Output Voltage vs Ambient temperature



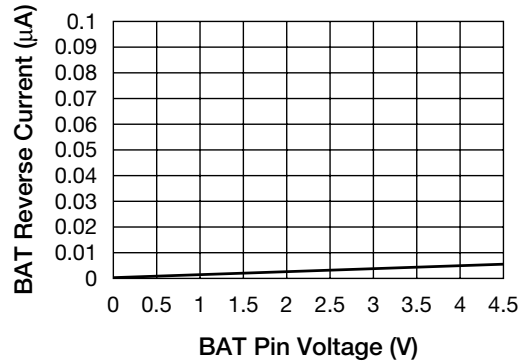
■ Current Detection Input/Output



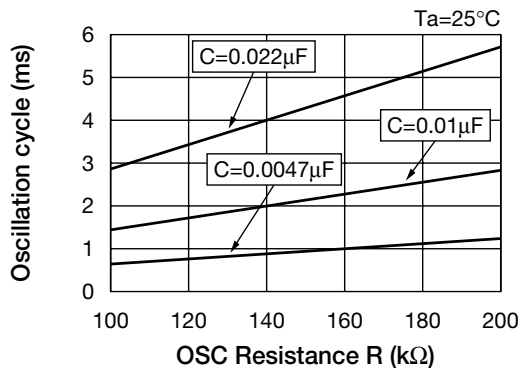
■ VCNT Voltage vs ICNT Current



■ BAT Pin Reverse Current vs BAT Pin Voltage



■ OSC Oscillation Cycle vs CR



■ ADP Detection H Delay Time

